

STM32WL_BGA73_Ref_Board_with_TCXO

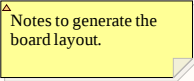
MB1842

Table of contents

- Sheet 1: Project overview (this page)
- Sheet 2: STM32WL_BGA73_Ref_Board_with_TCXO.SchDoc

Legend

- General comment such as function title, configuration, ...
- Text to be added to silkscreen.
- Warning text.



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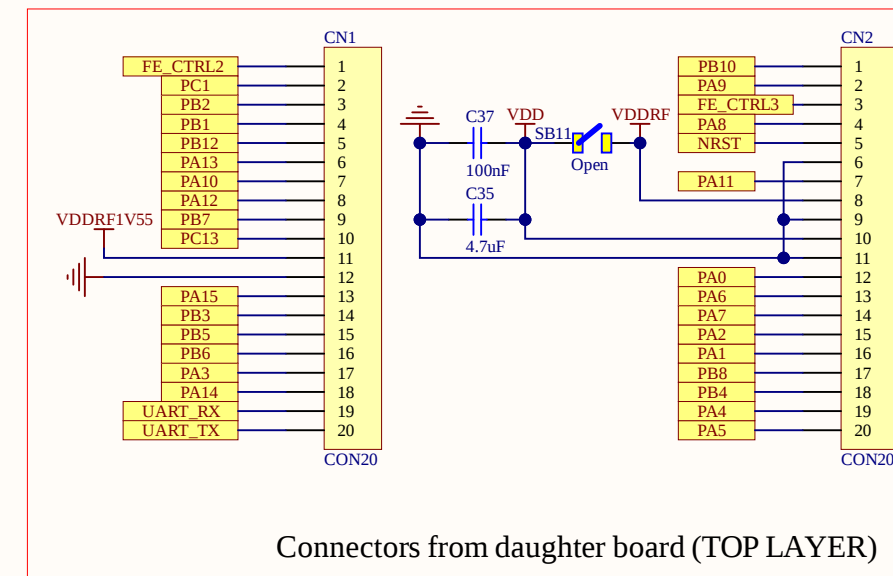
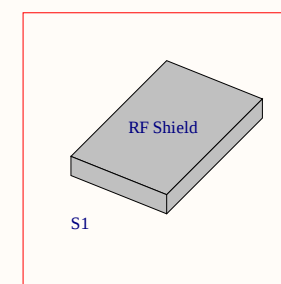
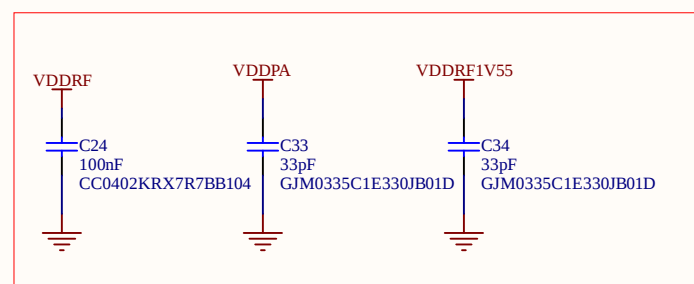
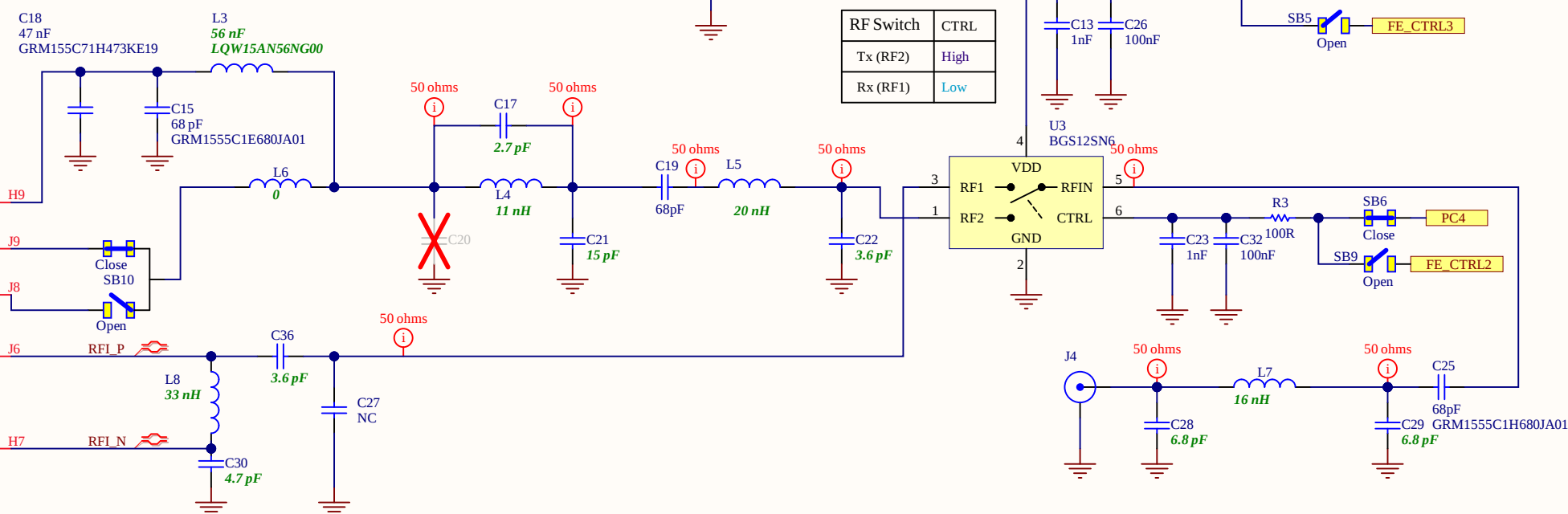
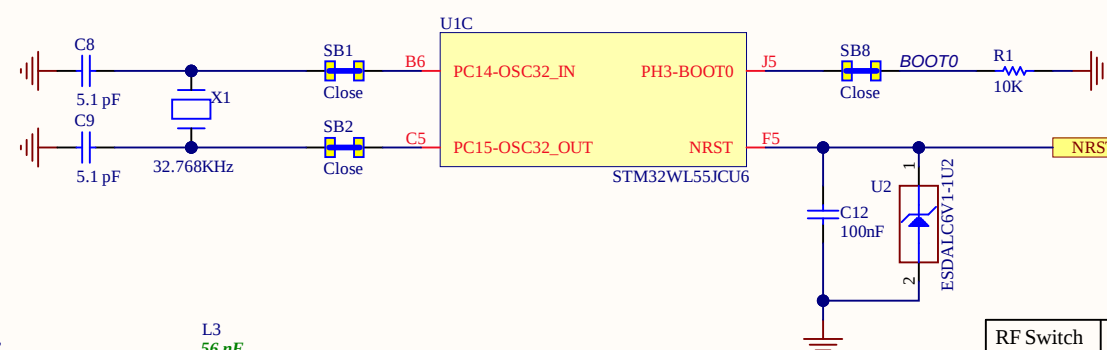
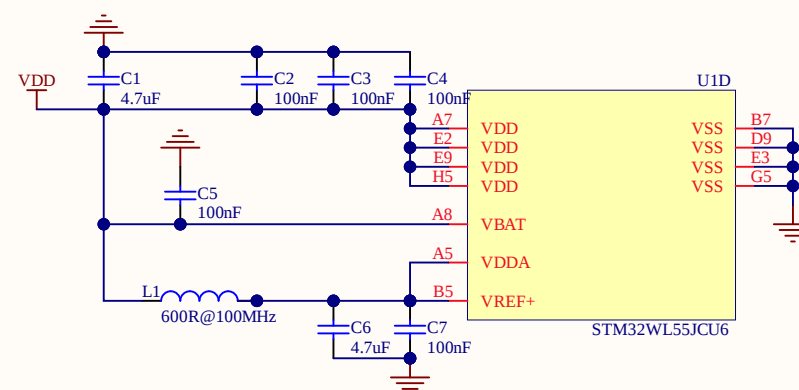
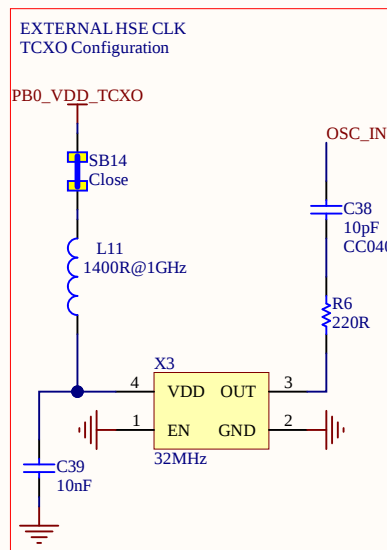
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STM32WL_BGA73_Ref_Board_with_TCXO.SchDoc



Title: Schematic sheet title to update		
Project: STM32WL_BGA73_Ref_Board_with_TCXO		
Variant: LowBand_HighPower		
Revision: A-01		Reference: MB1842
Size: A4	Date: 23-03-2022	Sheet: 1 of 2





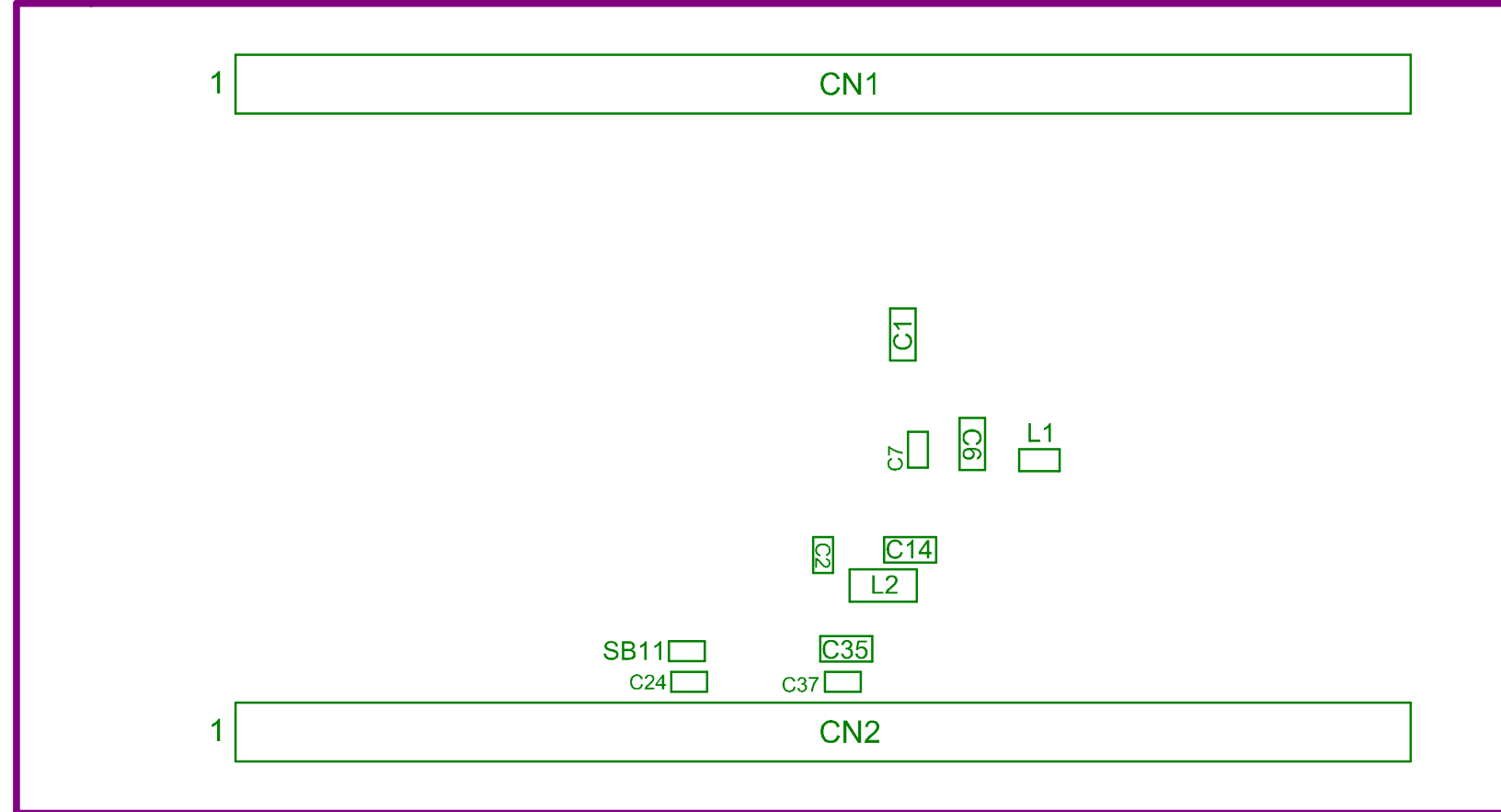
Notes:

RF BoM_LowBand_HighPower

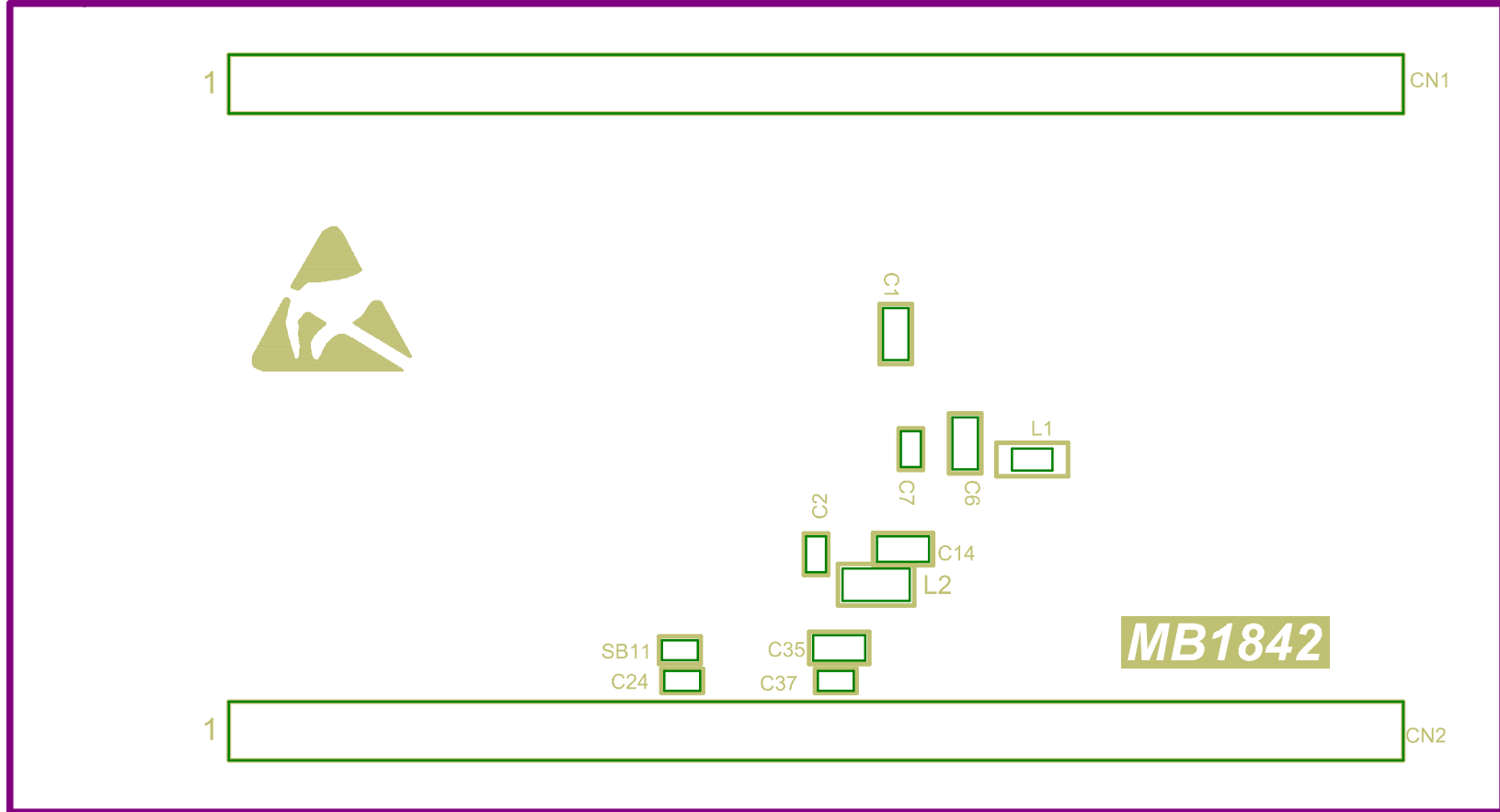
RF components:

- RF High-Q muRata GJM15 series for capacitors
- RF High-Q muRata LQW15AN series for inductors





Project: STM32WL_BGA73_Ref_Board_with_TCXO		
Layer: Bottom Assembly	Gerber: .GM15	
Variant: LowBand_HighPower	Ref: MB1842	
Date: 23-03-2022	Rev: A	



Bottom Overlay

.GBO